



res. and Mail
BOX AF

Handwritten: H4 / 280
Reply under 37 CFR 1.116
--Expedited Procedure--
Technology Center 2800

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE
COPY OF PAPERS
ORIGINALLY FILED

In re the Application of:

Azcarate, et al.

Serial No.: 09/392,899

Filed: 09/09/99

For: STRAPLESS LEAD FRAME

Docket No.: TI-22451

Examiner: Chambliss, A

Art Unit: 2814

Handwritten: #5 / AMOT B (not)
4-15-02
V8
underlined
5-29-02
T.BEC
RECEIVED
MAR - 5 2002
TC 2800 MAIL ROOM

Amendment under 37 CFR 1.116

Assistant Commissioner of Patents
Washington, DC 20231

MAILING CERTIFICATE UNDER 37 C.F.R. §1.8(A)

I hereby certify that this correspondence is being deposited with the
U.S. Postal Service as First Class Mail in an envelope addressed to:
Assistant Commissioner for Patents, Washington, D.C. 20231 on

02-08-02

Marianna Smith
Marianna Smith

Dear Sir:

Handwritten: Do not enter this amendment
C
4/8/02
The following amendments and remarks are offered in response to the
Examiner's Office Action dated 12/11/01. They are respectfully submitted as a
full and complete response to that Action.

Please amend the above-referenced application as follows:

In the Claims:

Please amend the claims as follows:

- Handwritten: 5/4/02
131
1. (twice amended) A strapless lead frame/heat slug combination, comprising:
lead frame leads, all of said leads being evenly distributed around a
semiconductor die mount area; and